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FDP023N08B

N-Channel PowerTrench® MOSFET

75 V, 242 A, 2.35 mΩ

Features

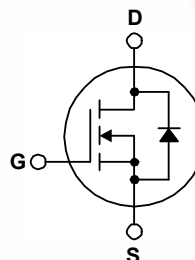
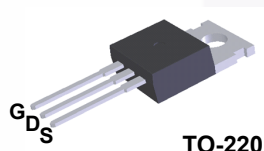
- $R_{DS(on)} = 1.96 \text{ m}\Omega$ (Typ.) @ $V_{GS} = 10 \text{ V}$, $I_D = 75 \text{ A}$
- Low FOM $R_{DS(on)} \cdot Q_G$
- Low Reverse Recovery Charge, Q_{rr}
- Soft Reverse Recovery Body Diode
- Enables Highly Efficiency in Synchronous Rectification
- Fast Switching Speed
- 100% UIL Tested
- RoHS Compliant

Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- DC motor Drives and Uninterruptible Power Supplies
- Micro Solar Inverte



MOSFET Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	FDP023N08B_F102	Unit
V_{DSS}	Drain to Source Voltage	75	V
V_{GSS}	Gate to Source Voltage	± 20	V
I_D	Drain Current	- Continuous ($T_C = 25^\circ\text{C}$, Silicon Limited)	A
		- Continuous ($T_C = 100^\circ\text{C}$, Silicon Limited)	
		- Continuous ($T_C = 25^\circ\text{C}$, Package Limited)	
I_{DM}	Drain Current	- Pulsed (Note 1)	A
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	V/ns
P_D	Power Dissipation	($T_C = 25^\circ\text{C}$)	W
		- Derate Above 25°C	W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +175	$^\circ\text{C}$
T_L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds	300	$^\circ\text{C}$

* Package limitation current is 120A.

Thermal Characteristics

Symbol	Parameter	FDP023N08B_F102	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.61	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDP023N08B_F102	FDP023N08B	TO-220	Tube	N/A	N/A	50 units

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
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Off Characteristics

BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250\ \mu\text{A}$, $V_{GS} = 0\text{ V}$, $T_C = 25^\circ\text{C}$	75	-	-	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\ \mu\text{A}$, Referenced to 25°C	-	0.35	-	$^\circ\text{V}/^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 60\text{ V}$, $V_{GS} = 0\text{ V}$ $V_{DS} = 60\text{ V}$, $T_C = 150^\circ\text{C}$	-	-	1 500	μA
I_{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20\text{ V}$, $V_{DS} = 0\text{ V}$	-	-	± 100	nA

On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250\ \mu\text{A}$	2.0	-	3.8	V
$R_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = 10\text{ V}$, $I_D = 75\text{ A}$	-	1.96	2.35	m Ω
g_{FS}	Forward Transconductance	$V_{DS} = 10\text{ V}$, $I_D = 75\text{ A}$	-	185	-	S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 37.5\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 1\text{ MHz}$	-	10350	13765	pF
C_{oss}	Output Capacitance		-	1855	2465	pF
C_{rss}	Reverse Transfer Capacitance		-	46.8	-	pF
$C_{oss(er)}$	Energy Related Output Capacitance	$V_{DS} = 37.5\text{ V}$, $V_{GS} = 0\text{ V}$	-	3290	-	pF
$Q_{g(tot)}$	Total Gate Charge at 10V	$V_{DS} = 37.5\text{ V}$, $I_D = 100\text{ A}$, $V_{GS} = 10\text{ V}$ (Note 4)	-	150	195	nC
Q_{gs}	Gate to Source Gate Charge		-	50.3	-	nC
Q_{gd}	Gate to Drain "Miller" Charge		-	31.7	-	nC
$V_{plateau}$	Gate Plateau Voltage		-	4.9	-	V
Q_{sync}	Total Gate Charge Sync.	$V_{DS} = 0\text{ V}$, $I_D = 50\text{ A}$	-	127.4	-	nC
Q_{oss}	Output Charge	$V_{DS} = 37.5\text{ V}$, $V_{GS} = 0\text{ V}$	-	146.2	-	nC

Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 37.5\text{ V}$, $I_D = 100\text{ A}$, $V_{GS} = 10\text{ V}$, $R_G = 4.7\ \Omega$ (Note 4)	-	41	92	ns
t_r	Turn-On Rise Time		-	71	151	ns
$t_{d(off)}$	Turn-Off Delay Time		-	111	232	ns
t_f	Turn-Off Fall Time		-	56	122	ns
ESR	Equivalent Series Resistance (G-S)	$f = 1\text{ MHz}$	-	2.23	-	Ω

Drain-Source Diode Characteristics

I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	242*	A
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	968	A
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 75 A	-	-	1.3	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, V _{DD} =37.5 V, I _{SD} = 100 A, dI _F /dt = 100 A/μs	-	79.3	-	ns
Q _{rr}	Reverse Recovery Charge		-	114	-	nC

Notes:

1. Repetitive rating; pulse-width limited by maximum junction temperature.
2. $L = 3\text{ mH}$, $I_{AS} = 25.32\text{ A}$, starting $T_J = 25^\circ\text{C}$.
3. $I_{SD} \leq 100\text{ A}$, $dI/dt \leq 200\text{ A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, starting $T_J = 25^\circ\text{C}$.
4. Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

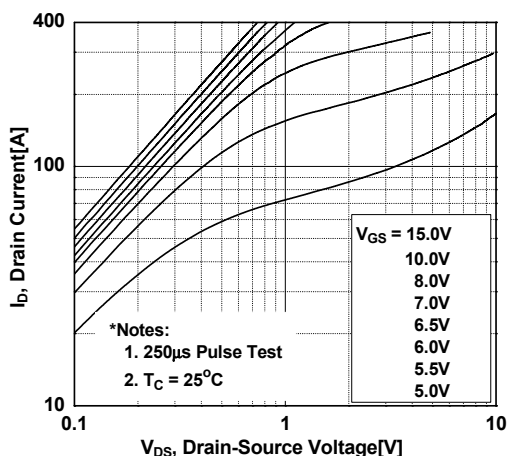


Figure 2. Transfer Characteristics

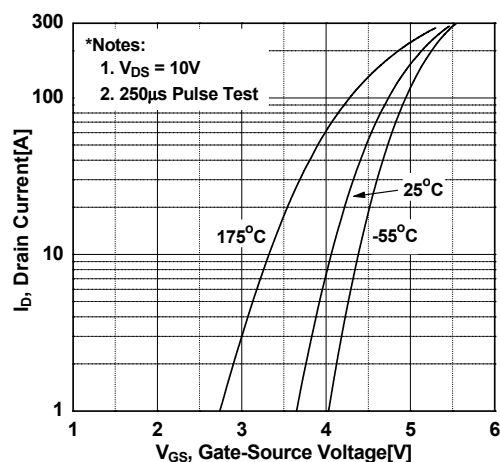


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

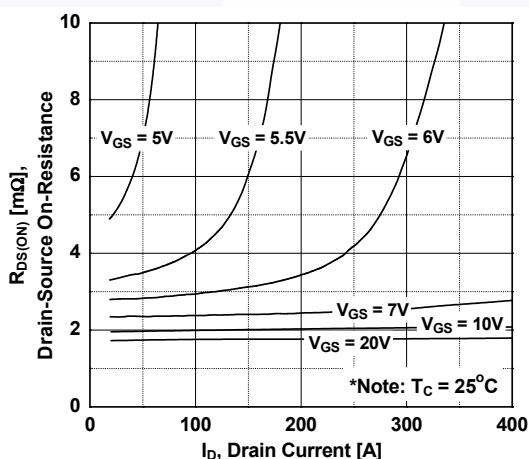


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

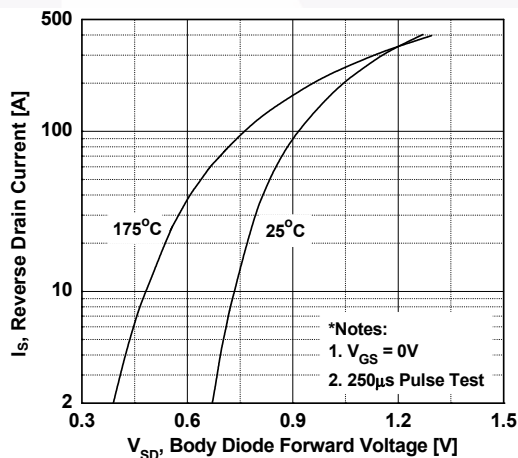


Figure 5. Capacitance Characteristics

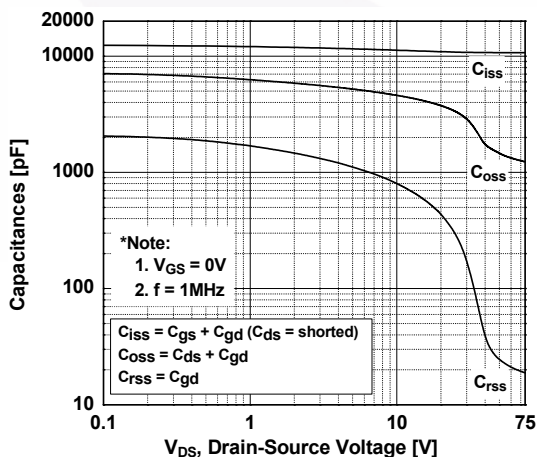
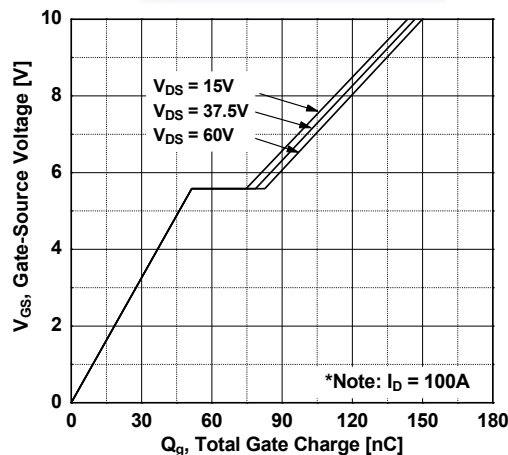


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

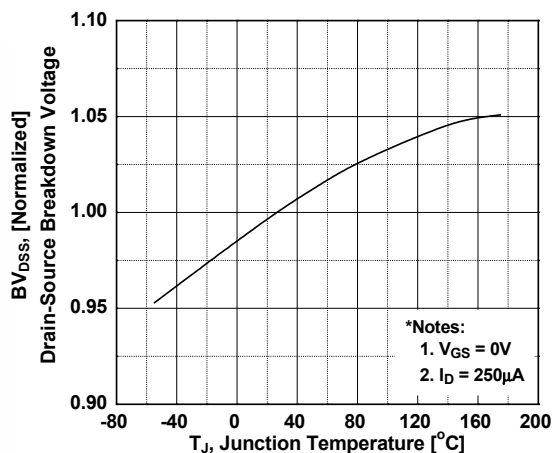


Figure 8. On-Resistance Variation vs. Temperature

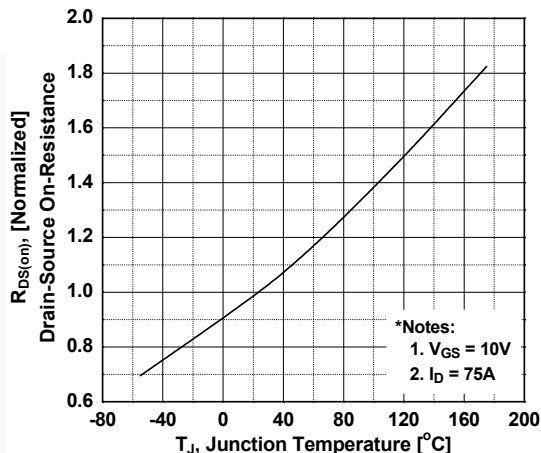


Figure 9. Maximum Safe Operating Area

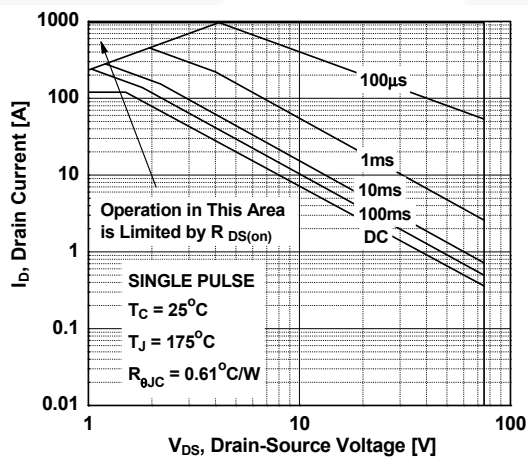


Figure 10. Maximum Drain Current vs. Case Temperature

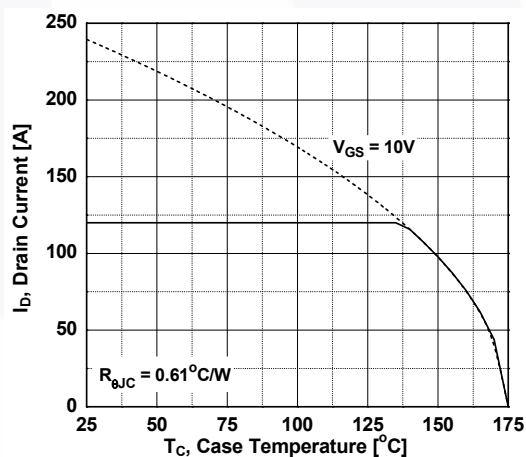


Figure 11. Eoss vs. Drain to Source Voltage

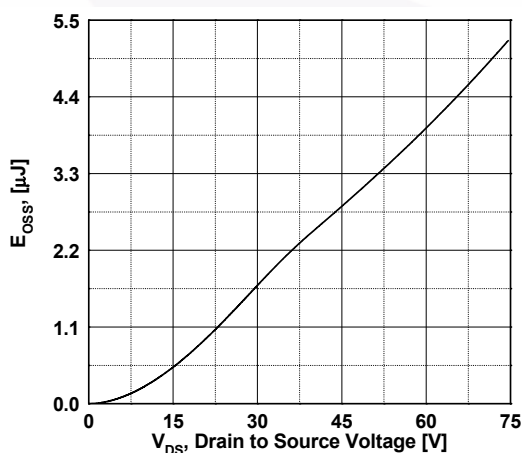
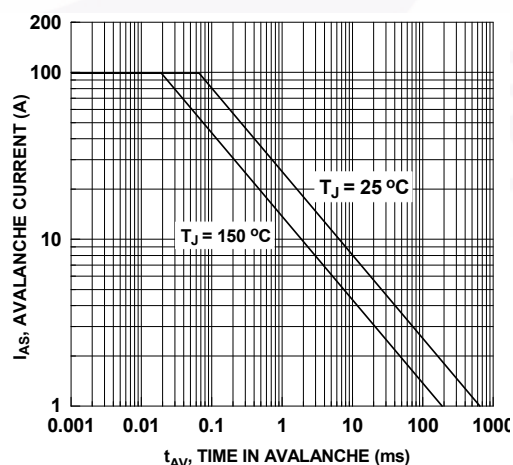
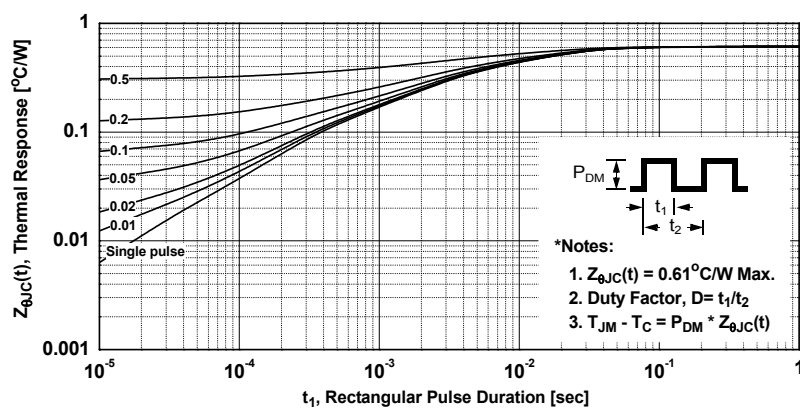


Figure 12. Unclamped Inductive Switching Capability



Typical Performance Characteristics (Continued)

Figure 13. Transient Thermal Response Curve



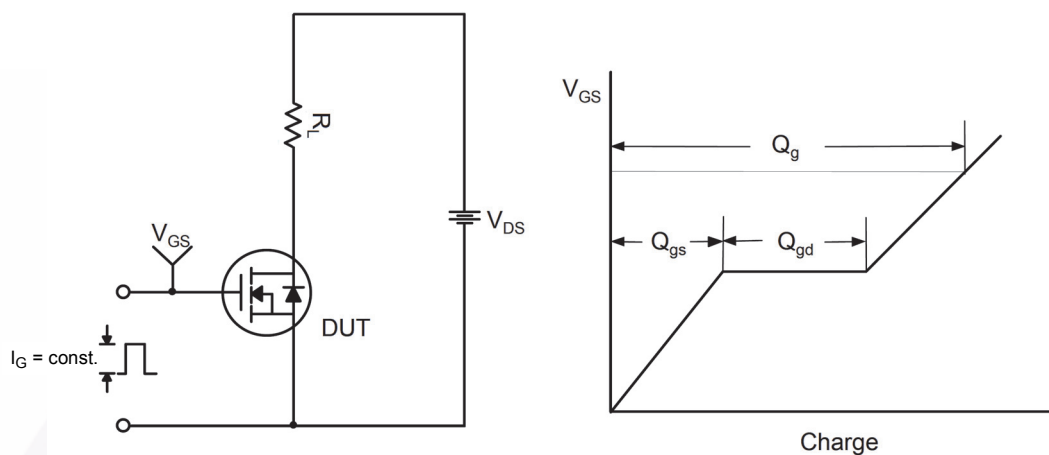


Figure 14. Gate Charge Test Circuit & Waveform

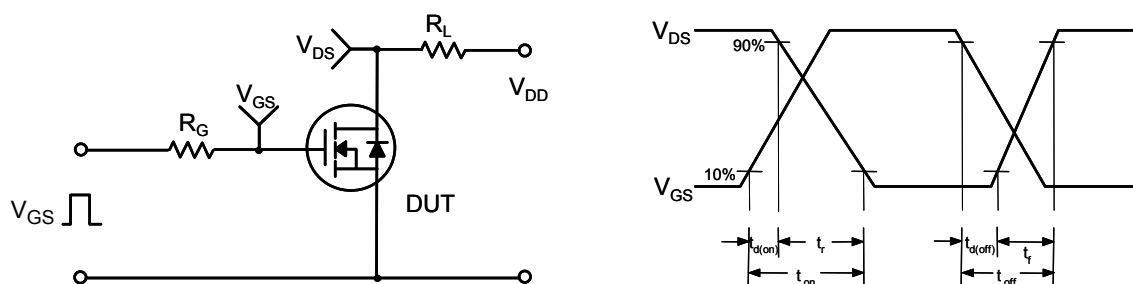


Figure 15. Resistive Switching Test Circuit & Waveforms

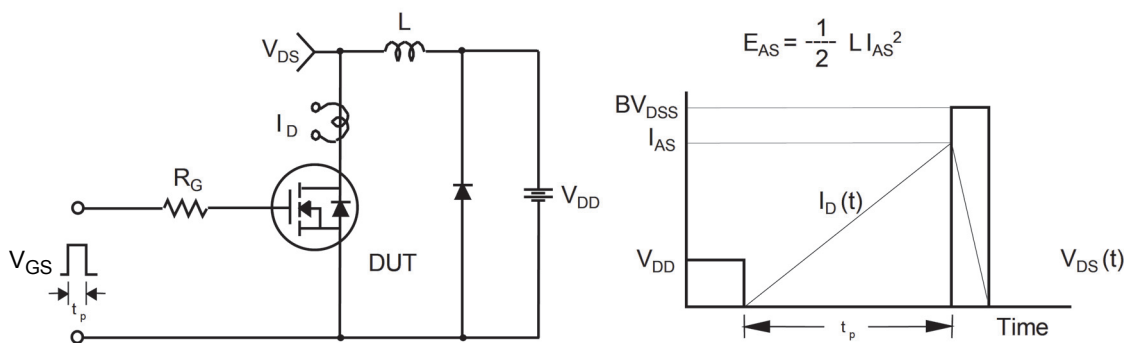


Figure 16. Unclamped Inductive Switching Test Circuit & Waveforms

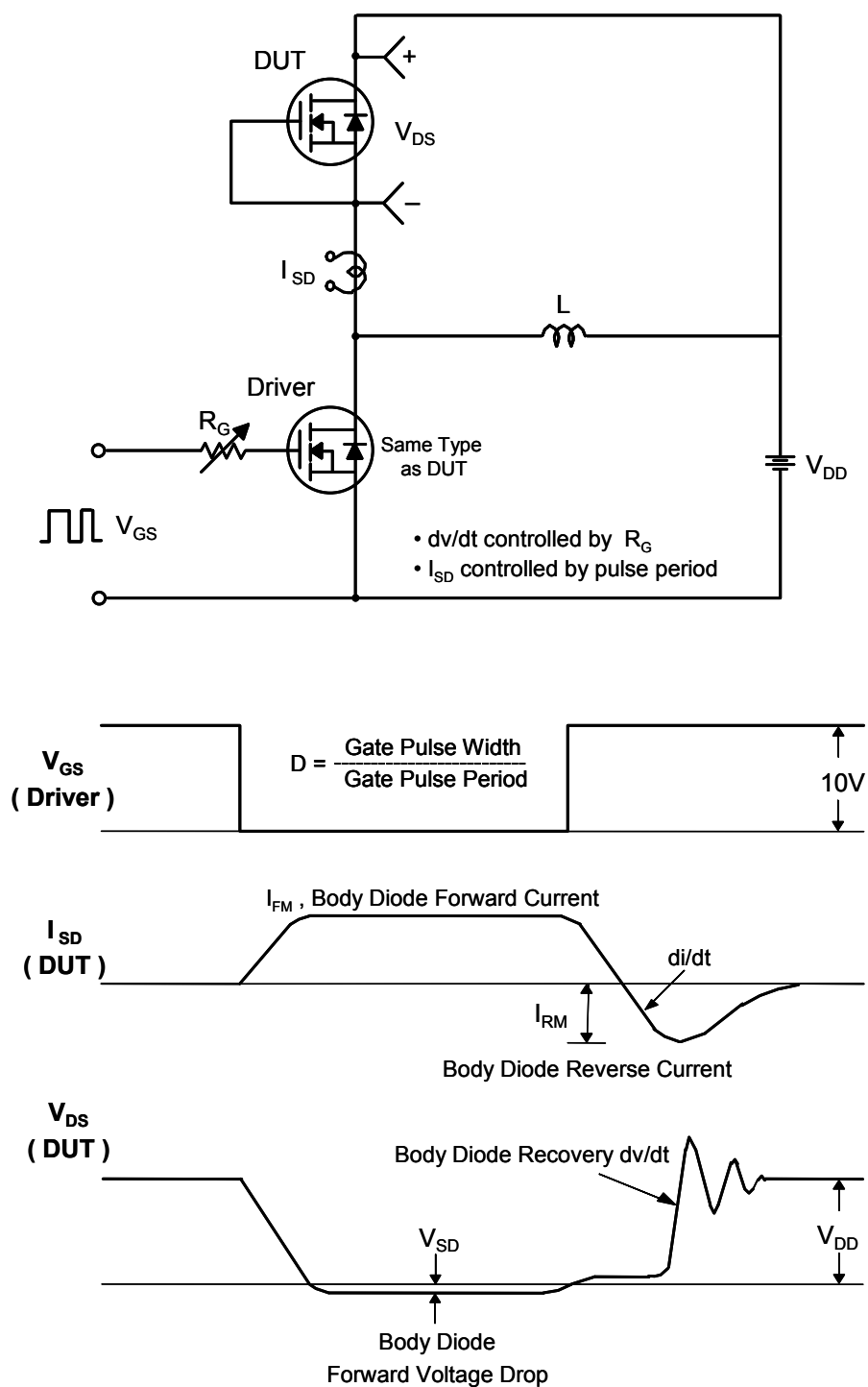


Figure 17. Peak Diode Recovery dv/dt Test Circuit & Waveforms

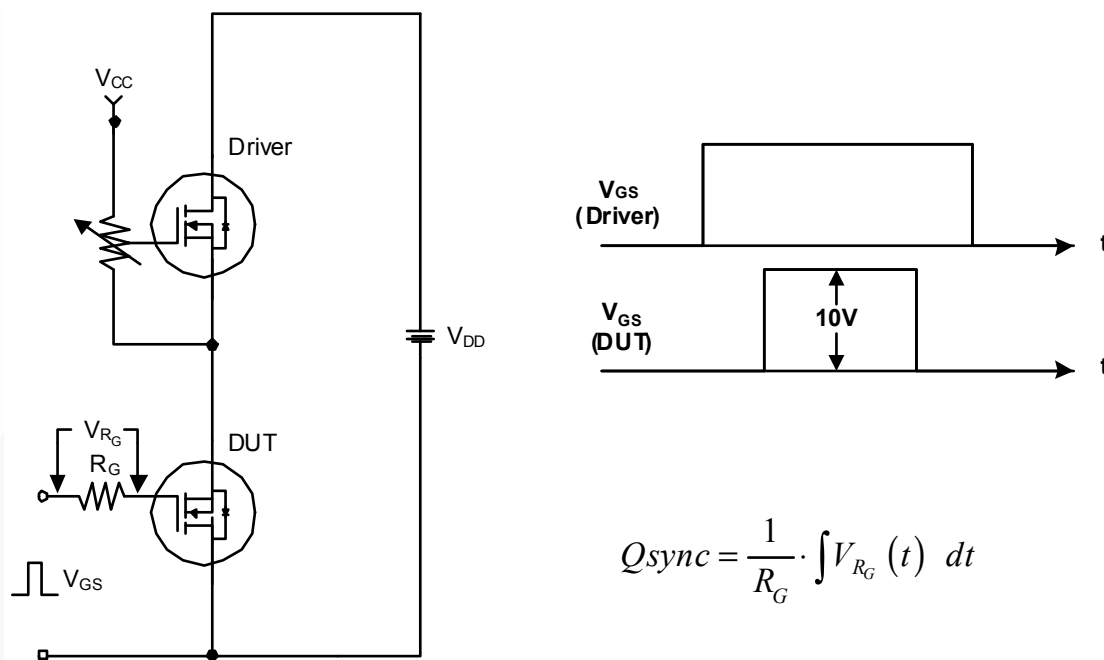


Figure 18. Total Gate Charge Q_{sync} . Test Circuit & Waveforms

Mechanical Dimensions

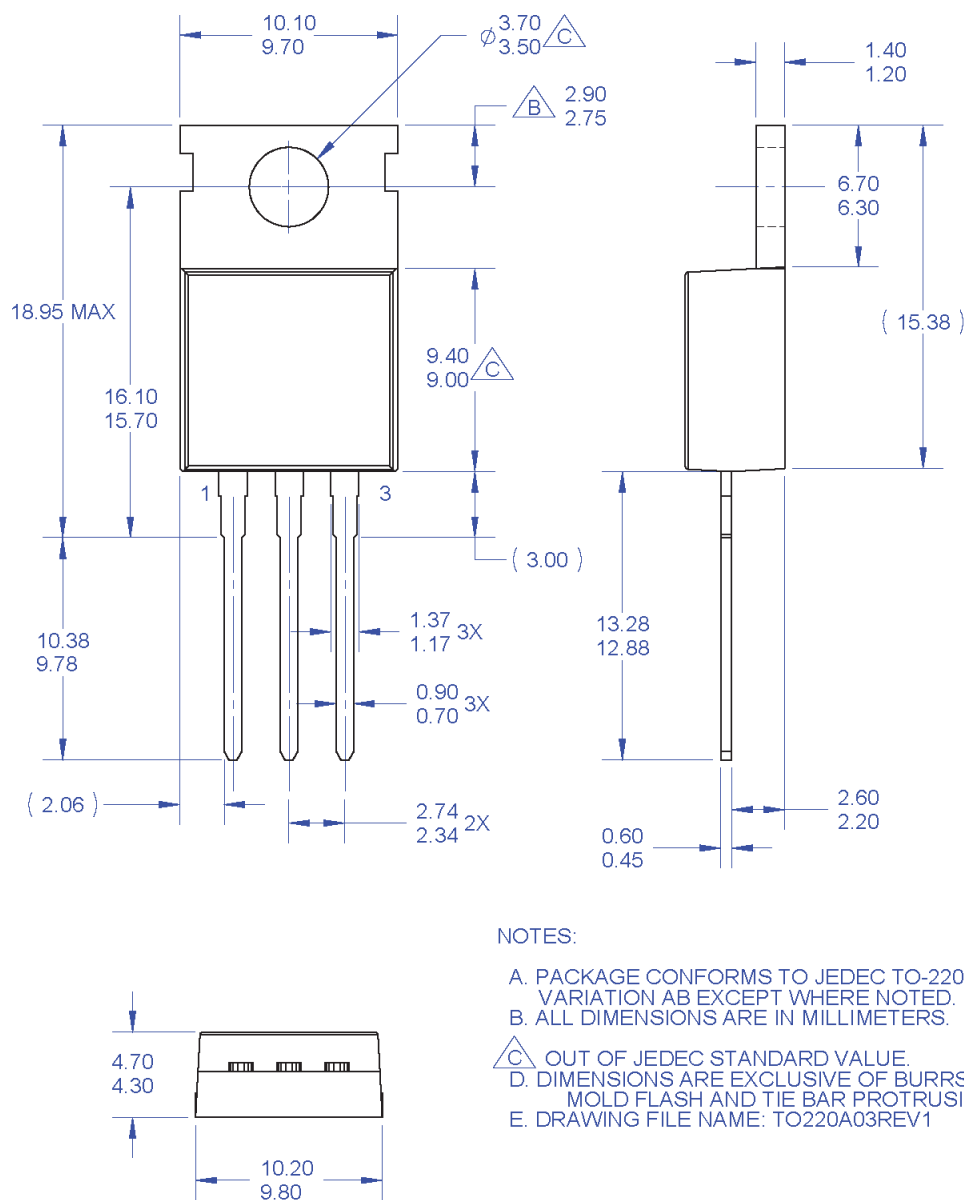


Figure 19. TO220, Molded, 3-Lead, Jedec Variation AB, Non Jedec F102

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